AWB7032

2.30 to 2.40 GHz

Small-Cell Power Amplifier Module ATA SHEET - Rev 2.1

SKYWORKS[®]

FEATURES

- InGaP HBT Technology
- -47 dBc ACPR @ + 10 MHz, +24.5 dBm
- 29 dB Gain
- High Efficiency
- Low Transistor Junction Temperature
- Internally matched for a 50 Ω System
- Low Profile Miniature Surface Mount Package; Halogen Free and RoHS Compliant
- Multi-Carrier Capability

APPLICATIONS

- LTE, WCDMA and HSDPA Air Interfaces
- Picocell, Femtocell, Home Nodes
- Customer Premises Equipment (CPE)
- Data Cards and Terminals

14 Pin 5 mm x 5 mm x 1 mm

Surface Mount Module

PRODUCT DESCRIPTION

The AWB7032 is a highly linear, fully matched, power amplifier module designed for picocell, femtocell, and customer premises equipment (CPE) applications. Its high power, efficiency, and low adjacent channel power levels meet the extremely demanding needs of small cell infrastructure architectures. Designed for LTE, WCDMA, HSDPA air interfaces operating in the 2.30 GHz to 2.40 GHz band, the AWB7032 delivers up to +24.5 dBm of LTE (E-TM1.1) power with an ACPR of -47 dBc. It operates from a convenient +4.2 V supply and provides 29 dB of gain. The device is manufactured using an advanced InGaP HBT MMIC technology offering state-of-the-art reliability, temperature stability, and ruggedness. The self-contained 5 mm x 5 mm x 1 mm surface mount package incorporates RF matching networks optimized for output power, efficiency, and linearity in a 50 Ω system.

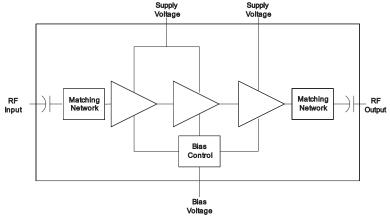


Figure 1: Block Diagram

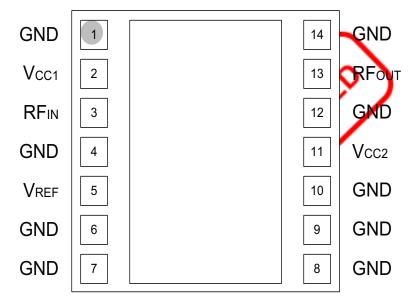


Figure 2: Pinout (X-ray Top View)

Table 1: Pin Description

PIN	NAME	DESCRIPTION
1	GND	Ground
2	V _{CC1}	Supply Voltage
3	RFℕ	RF Input
4	GND	Ground
5	V_{REF}	Reference Voltage
6	GND	Ground
7	GND	Ground
8	GND	Ground
9	GND	Ground
10	GND	Ground
11	V _{CC2}	Supply Voltage
12	GND	Ground
13	RFоит	RF Output
14	GND	Ground

ELECTRICAL CHARACTERISTICS

Table 2: Absolute Minimum and Maximum Ratings

PARAMETER	MIN	MAX	UNIT
Supply Voltage (Vcc)	0	+5	> v
Reference Voltage (VREF)		+3.5	
RF Output Power (Роит)		+28	dBm, modulated
RF Input Power (PIN)	0	+10	dBm, CW
ESD Rating Human Body Model (1) Charged Device Model (2)	Class 1C Class IV	-	
MSL Rating (3)	4	-	
Junction Temperature (TJ)	-	+150	°C
Storage Temperature (Tstg)	-40	+150	°C

Functional operation is not implied under these conditions. Exceeding any one or a combination of the Absolute Maximum Rating Conditions may cause permanent damage to the device. Exposure to absolute ratings for extended periods of time may adversely affect reliability.

Notes:

- (1) JEDEC JS-001-2010.
- (2) JEDEC JESD22-C101D.
- (3) 260 °C peak reflow.

Table 3: Operating Ranges

PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS
Operating Frequency (f)	2300	-	2400	MHz	
Supply Voltage (Vcc)	+3.2	+4.2	+4.5	V	
Reference Voltage (VREF)	+2.80 0	+2.85 -	+2.90 +0.5	٧	PA "on" PA "shut down"
RF Output Power (Pout) (1)	-	+24.5	-	dBm	
Case Temperature (Tc) (2)	-40	1	+85	°C	

The device may be operated safely over these conditions; however, parametric performance is guaranteed only over the conditions defined in the electrical specifications.

Notes:

- (1) Typ RF Output Power is used during production test.
- (2) Case Temperature references the board temperature at the ground paddle on the backside of the package.

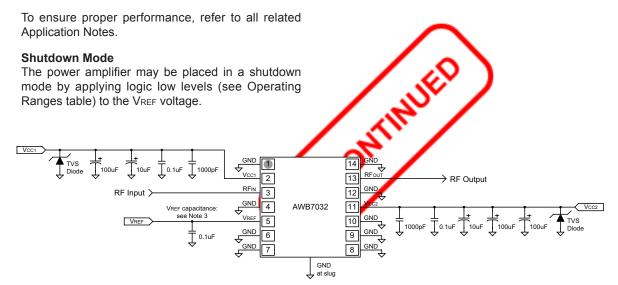
Table 4: Electrical Specifications (Tc = +25 °C, Vcc = +4.2 V, VREF = +2.85 V, 50 Ω system)

PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS
Gain (2)	26.5	29	36	dB	
ACPR (1), (2), (3) @ 10 MHz @ 20 MHz	- -	-47 -58	-45 -54	dBc	JEL)
Power-Added Efficiency (1), (2), (3)	14.0	17.5		%	
Thermal Resistance (RJC)	-	24.9	-	°C/W	Junction to Case
Supply Current (1), (2), (3)	-	385	480	mA	total through Vcc pins
Quiescent Current (Icq)	-	130	190	mA	
Reference Current	-	7	12	mA	through VREF pin
Leakage Current	-	1.5	5	μΑ	Vcc = +4.5 V, VREF = 0 V
Harmonics 2fo 3fo, 4fo	- -	-55 -58	-40 -45	dBc	
Input Return Loss	8	15	-	dB	
P1dB	-	TBD	-	dBm	CW tone
RF Switching Time ⁽⁴⁾ Rise Time (PA "off" to "on") Fall Time (PA "on" to "off")	-	-	12 4	μS	Vcc = +4.2, VREF switched between 0 V and +2.85 V
Spurious Output Level (all spurious outputs)	-	-	-60	dBc	Pout ≤ +24.5 dBm In-band load VSWR < 5:1 Out-of-band load VSWR < 10:1 Applies over all voltage and temperature operating ranges
Load mismatch stress with no permanent degradation or failure	8:1	-	-	VSWR	Vcc = +4.2 V, P _{IN} = 0 dBm Applies over full operating temperature range

Notes:

- (1) Measured at 2350 MHz.
- (2) $P_{OUT} = +24.5 \text{ dBm}.$
- (3) E-TM1.1 LTE 10 MHz BW.
- (4) Rise Time defined from time at which VREF is switched from 0 V to +2.85 V, to time at which the RF output power achieves 90% of the average steady-state "on" level; Fall Time defined from time at which VREF is switched from +2.85 V to 0 V, to time at which the RF output power decreases to 10% of the average steady-state "on" level.

APPLICATION INFORMATION



Notes:

- 1. 10uF and 100uF capacitors are optional.
- Applications that have large supply voltage transients may benefit from the use of TVS diodes. For such applications, recommended TVS diodes are SM05T1G or SMJ5.0A.
- 3. To achieve the RF Switching Time specifications listed in Table 4, the maximum recommended capacitance on the V_{REF} line is 0.01µF. The noise on the V_{REF} line should be kept as low as possible to minimize required capacitance.

Figure 3: Application Circuit Schematic

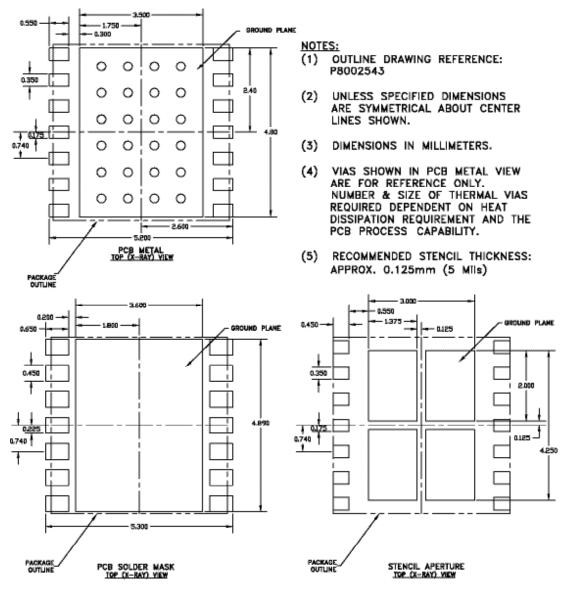
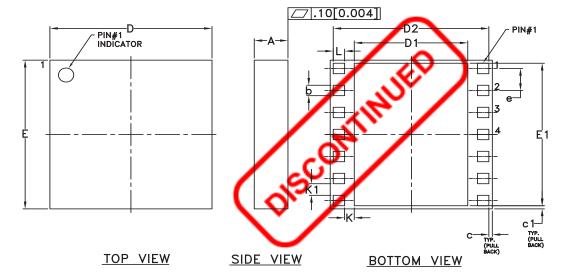


Figure 4: PCB Footprint

PACKAGE OUTLINE



S _{YMBOL}	MILLIMETERS			INCHES			NOTE
-0 _L	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.88	0.98	1.08	0.035	0.039	0.043	_
Ь	0.33	0.35	0.38	0.013	0.014	0.015	_
С	-	0.10	_	_	0.004	_	_
с1	-	0.10	_	_	0.004	_	_
D	4.90	5.00	5.10	0.193	0.197	0.201	_
D1	3.45	3.50	3.55	0.136	0.138	0.140	-
D2	4.75	4.80	4.85	0.187	0.189	0.191	_
Ε	4.90	5.00	5.10	0.193	0.197	0.201	_
E1	4.75	4.80	4.85	0.187	0.189	0.191	_
е	0.74				0.029		_
K	0.25	0.30	0.35	0.010	0.012	0.014	_
K1	0.34	0.39	0.44	0.013	0.015	0.017	-
L	0.33	0.35	0.38	0.013	0.014	0.015	_

NOTES:

- 1. CONTROLLING DIMENSIONS: MILLIMETERS
 2. UNLESS SPECIFIED TOLERANCE=±0.076[0.003].
 3. PADS (INCLUDING CENTER) SHOWN
 UNIFORM SIZE FOR REFERENCE ONLY.
 ACTUAL PAD SIZE AND LOCATION WILL
 VARY WITHIN MIN. AND MAX. DIMENSIONS
 ACCORDING TO SPECIFIC LAMINATE DESIGN.
- 4. METAL PAD DIMENSION IS MEASURED AT THE BOTTOM OF THE METAL LAYER.

Figure 5: Package Outline - 14 Pin 5 mm x 5 mm x 1 mm Surface Mount Module

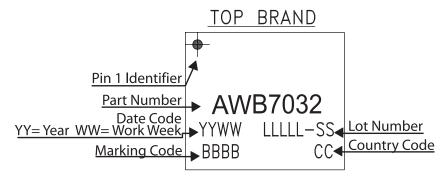
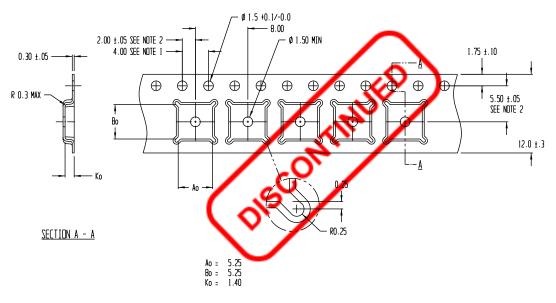


Figure 6: Branding Specification



NOTES:

- 1. 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE ±0.2
 2. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET, NOT POCKET HOLE
- Ao and bo are calculated on a plane at a distance "R"
 Above the bottom of the pocket.

Figure 7: Tape & Reel Packaging

Table 5: Tape & Reel Dimensions

PACKAGE TYPE	TAPE WIDTH	POCKET PITCH	REEL CAPACITY	MAX REEL DIA
5 mm x 5 mm x 1 mm	12 mm	8 mm	2500	13"

ORDERING INFORMATION

ORDER NUMBER	TEMPERATURE RANGE	PACKAGE DESCRIPTION	COMPONENT PACKAGING
AWB7032P7	-40 °C to +85 °C	Halogen Free RoHS Compliant 14 Pin 5 mm x 5 mm x 1 mm Surface Mount Module	Loose in Bag
AWB7032P8	-40 °C to +85 °C	Halogen Free RoHS Compliant 14 Pin 5 mm x 5 mm x 1 mm Surface Mount Module	Tape and Reel, 2500 pieces per Reel
AWB7032P9	-40 °C to +85 °C	Halogen Free Ro HS Compliant 14 Pin 5 mm x 5 mm x 1 mm Surface Mount Module	Partial Reel

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